

Wuxi Unigroup Microelectronics Co.,Ltd.

60V N-Channel Trench MOSFET

General Description		Product Summary				
 Trench Power SGT technology Very low on-resistance R_{DS(ON)} Low Gate Charge Excellent Gate Charge x R_{DS(ON)} Product 			V_{DS} $I_{D} (at V_{GS} = 10V)$ $R_{DS(ON)} (at V_{GS} = 10V)$ $R_{DS(ON)} (at V_{GS} = 4.5V)$	60V 60A < 9mΩ < 13.5mΩ		
ApplicationsHigh Frequency Switching a	nd Synchronous	100% UIS Tested	RoHS			
	TO-251		G			
Part Number	Packa	ige Type	Form	Marking		
TSU12N06A)-251	Tube	U12N06AT		
Absolute Maximum Ra Parameter	tings (T _A =2	5ºC unless o	otherwise noted)	Units		
	tings (T _A =2			Units V		
Parameter	ntings (T _A =2	Symbol	Maximum			
Parameter Drain-Source Voltage	T _c =25°C T _c =100°C	Symbol V _{DS}	Maximum 60	V		
Parameter Drain-Source Voltage Gate-Source Voltage	T _C =25°C	Symbol V _{DS} V _{GS}	Maximum 60 ±20 60	V V		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current	T _C =25°C	Symbol V _{DS} V _{GS} I _D	Maximum 60 ±20 60 36	V V A		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current	T _C =25°C	Symbol V _{DS} V _{GS} I _D I _{DM}	Maximum 60 ±20 60 240	V V A A		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy	$ T_{C} = 25^{\circ}C T_{C} = 100^{\circ}C $	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS}	Maximum 60 ±20 60 240 36	V V A A A A		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current	$T_{c} = 25^{\circ}C$ $T_{c} = 100^{\circ}C$ L = 0.3mH ^A	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS}	Maximum 60 ±20 60 240 36 65	V V A A A A mJ		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy	$ \begin{array}{c} T_{C} = 25^{\circ}C \\ T_{C} = 100^{\circ}C \\ \end{array} $ $ \begin{array}{c} L = 0.3mH & ^{A} \\ T_{C} = 25^{\circ}C \\ \hline T_{C} = 100^{\circ}C \\ \end{array} $	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS}	Maximum 60 ±20 60 240 36 65 56.5	V V A A A M M W		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy Power Dissipation C	$ \begin{array}{c} T_{C} = 25^{\circ}C \\ T_{C} = 100^{\circ}C \\ \end{array} $ $ \begin{array}{c} L = 0.3mH & ^{A} \\ T_{C} = 25^{\circ}C \\ \hline T_{C} = 100^{\circ}C \\ \end{array} $	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D	Maximum 60 ±20 60 36 240 36 56.5 44	V V A A A M M W W		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current B Pulsed Drain Current Avalanche Current A Single Pulse Avalanche Energy Power Dissipation C Junction and Storage Temperation	$ \begin{array}{c} T_{C} = 25^{\circ}C \\ T_{C} = 100^{\circ}C \\ \end{array} $ $ \begin{array}{c} L = 0.3mH & ^{A} \\ T_{C} = 25^{\circ}C \\ \hline T_{C} = 100^{\circ}C \\ \end{array} $	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D	Maximum 60 ±20 60 36 240 36 56.5 44	V V A A A M J W W		
Parameter Drain-Source Voltage Gate-Source Voltage Continuous Drain Current Pulsed Drain Current Avalanche Current Avalanche Current Power Dissipation C Junction and Storage Temperatu Thermal Characteristics	$ \begin{array}{c} T_{C} = 25^{\circ}C \\ T_{C} = 100^{\circ}C \\ \end{array} $ $ \begin{array}{c} L = 0.3mH & ^{A} \\ T_{C} = 25^{\circ}C \\ \hline T_{C} = 100^{\circ}C \\ \end{array} $	Symbol V _{DS} V _{GS} I _D I _{DM} I _{AS} E _{AS} P _D T _J , T _{STG}	Maximum 60 ±20 60 36 240 36 65 56.5 44 -55 to 175	V V A A A M M W W W V V C		



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Electrica	al Characteristics(T _J =25ºC un	less otherwise n	oted)				
0		Conditions		Value			
Symbol	Parameter			Min	Тур	Max	Units
STATIC PA	RAMETERS	•				-	
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250µA,V _{GS} =0V		60			V
I _{DSS} Zero Gate Voltage Drain	Zaro Cata Valtaga Drain Current	V _{DS} =60V, V _{GS} =0V	T _J =25°C			1	μA
			T _J =125°C	-		100	
I _{GSS}	Gate-Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$				±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA		1.1		2.5	V
D	Ctatia Drain Caura On Desistance	V _{GS} =10V, I _D = 20A		6.5	9	mΩ	
R _{DS(ON)} Stati	Static Drain-Source On-Resistance	V _{GS} = 4.5V, I _D = 20A		10.7	13.5	mΩ	
9 _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A			85		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V			1	V	
I _S	Maximum Body-Diode Continuous Current					46	А
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f =1MH _Z			2455		pF
C _{oss}	Output Capacitance				240		
C _{rss}	Reverse Transfer Capacitance				34		
SWITCHIN	G PARAMETERS				-	-	
Q _g (10V)	Total Cata Charge			-	45		nC
Q _g (4.5V)	Total Gate Charge			24			
Q _{gs}	Gate Source Charge	– V _{GS} =10V,V _{DS} =30V, I _D =20A			6.8		
Q_{gd}	Gate Drain Charge				11.5		
t _{D(on)}	Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 30V, I_{D} = 20A, R_{G} = 3\Omega$			8		- ns
t _r	Turn-On Rise Time				3		
T _{D(off)}	Turn-Off Delay Time				25		
t _f	Turn-Off Fall Time				4		
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, di/dt =500A/μs			25		ns
Q _{rr}	Body Diode Reverse Recovery Charge				110		nC

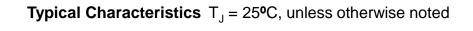
A. Single pulse width limited by maximum junction temperature.

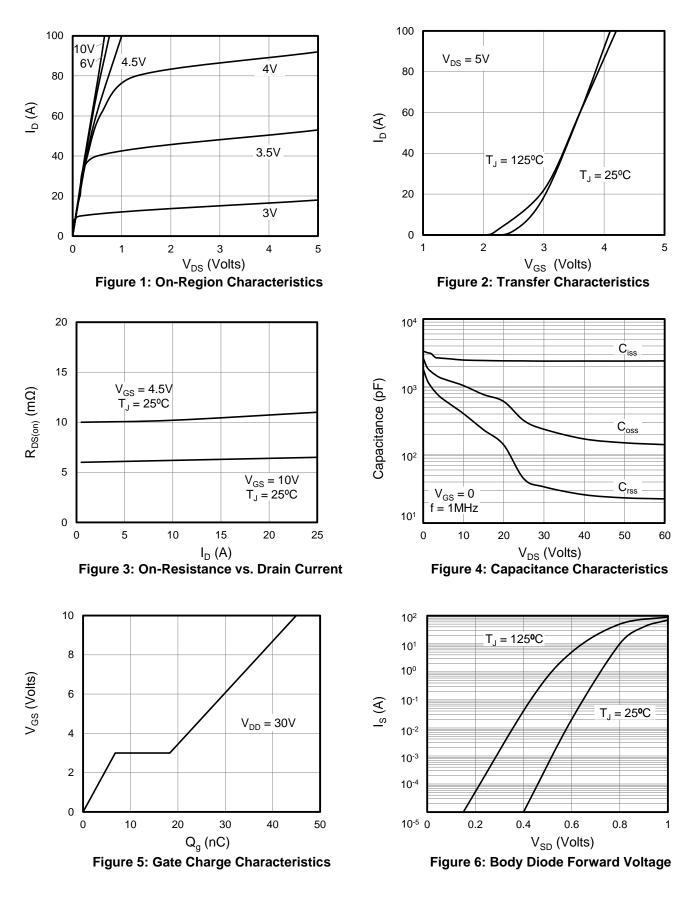
B. The maximum current rating is package limited.

C. The power dissipation P_D is based on $T_{J(MAX)} = 175^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



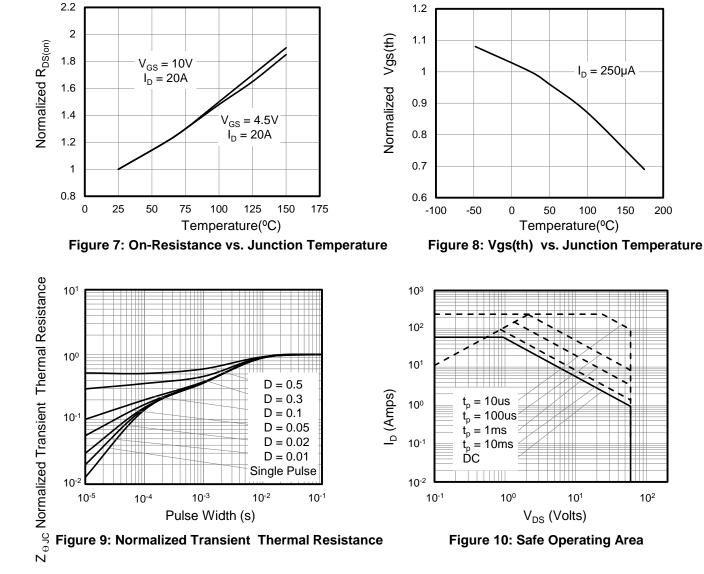
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V1.0

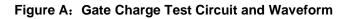
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Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

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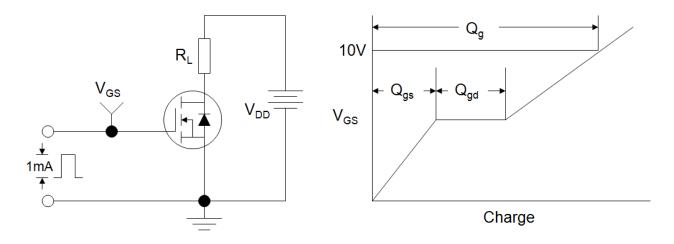


Figure B: Resistive Switching Test Circuit and Waveform

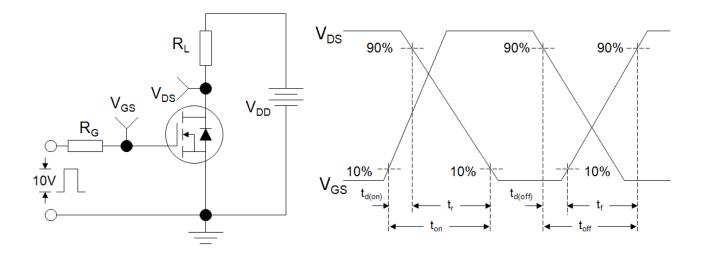
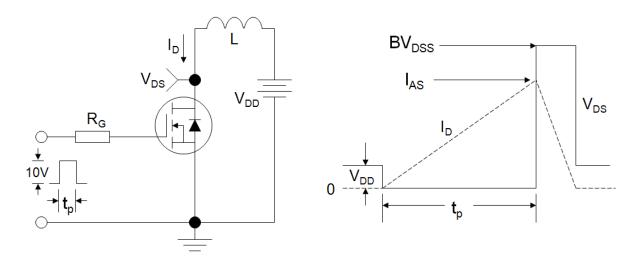
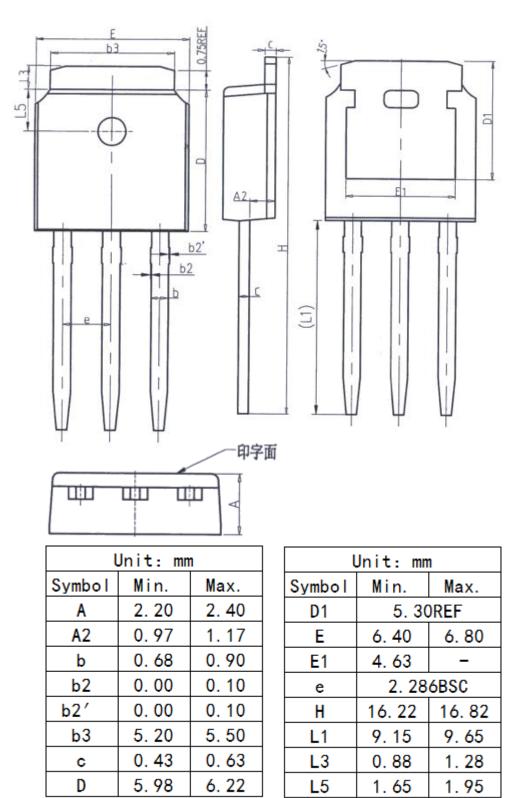


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



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TO-251



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